FAIRCHILD SEMICONDUCTOR®

July 2008

FGH40N60SFD
600V, 40A Field Stop IGBT

Features

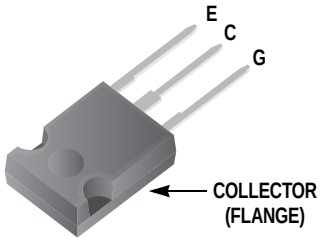
- High current capability
- Low saturation voltage: $V_{CE(sat)}$ =2.3V @ I_C = 40A
- High input impedance
- Fast switching
- RoHS compliant

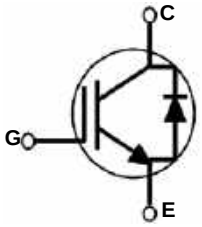
Applications

- Induction Heating, UPS, SMPS, PFC

General Description

Using Novel Field Stop IGBT Technology, Fairchild's new series of Field Stop IGBTs offer the optimum performance for Induction Heating, UPS, SMPS and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Units
V_{CES}	Collector to Emitter Voltage		600	V
V_{GES}	Gate to Emitter Voltage		± 20	V
I_C	Collector Current	@ T_C = 25°C	80	A
	Collector Current	@ T_C = 100°C	40	A
$I_{CM\ (1)}$	Pulsed Collector Current	@ T_C = 25°C	120	A
P_D	Maximum Power Dissipation	@ T_C = 25°C	290	W
	Maximum Power Dissipation	@ T_C = 100°C	116	W
T_J	Operating Junction Temperature		-55 to +150	°C
T_{stg}	Storage Temperature Range		-55 to +150	°C
T_L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:
1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$(IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W
$R_{\theta JC}$(Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Packaging Type	Qty per Tube	Max Qty per Box
FGH40N60SFD	FGH40N60SFDTU	TO-247	Tube	30ea	-

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0V, I_C = 250μA	600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	V_{GE} = 0V, I_C = 250μA	-	0.6	-	V/°C
I_{CES}	Collector Cut-Off Current	V_{CE} = V_{CES}, V_{GE} = 0V	-	-	250	μA
I_{GES}	G-E Leakage Current	V_{GE} = V_{GES}, V_{CE} = 0V	-	-	±400	nA
On Characteristics						
$V_{GE(th)}$	G-E Threshold Voltage	I_C = 250μA, V_{CE} = V_{GE}	4.0	5.0	6.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	I_C = 40A, V_{GE} = 15V	-	2.3	2.9	V
		I_C = 40A, V_{GE} = 15V, T_C = 125°C	-	2.5	-	V
Dynamic Characteristics						
C_{ies}	Input Capacitance	V_{CE} = 30V, V_{GE} = 0V, f = 1MHz	-	2110	-	pF
C_{oes}	Output Capacitance		-	200	-	pF
C_{res}	Reverse Transfer Capacitance		-	60	-	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{CC} = 400V, I_C = 40A, R_G = 10Ω, V_{GE} = 15V, Inductive Load, T_C = 25°C	-	25	-	ns
t_r	Rise Time		-	42	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	115	-	ns
t_f	Fall Time		-	27	54	ns
E_{on}	Turn-On Switching Loss		-	1.13	-	mJ
E_{off}	Turn-Off Switching Loss		-	0.31	-	mJ
E_{ts}	Total Switching Loss		-	1.44	-	mJ
$t_{d(on)}$	Turn-On Delay Time	V_{CC} = 400V, I_C = 40A, R_G = 10Ω, V_{GE} = 15V, Inductive Load, T_C = 125°C	-	24	-	ns
t_r	Rise Time		-	43	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	120	-	ns
t_f	Fall Time		-	30	-	ns
E_{on}	Turn-On Switching Loss		-	1.14	-	mJ
E_{off}	Turn-Off Switching Loss		-	0.48	-	mJ
E_{ts}	Total Switching Loss		-	1.62	-	mJ
Q_g	Total Gate Charge	V_{CE} = 400V, I_C = 40A, V_{GE} = 15V	-	120	-	nC
Q_{ge}	Gate to Emitter Charge		-	14	-	nC
Q_{gc}	Gate to Collector Charge		-	58	-	nC